

L Number	Hits	Search Text	DB	Time stamp
-	9	((("5474857") or ("6483155") or ("5668057"))).PN. or (2002/0014646).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 14:05
-	0	("sensorand19").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/13 23:27
-	1	(gaas with (LED or light adj1 emitting)) and (micromechanical adj sensor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/13 23:30
-	38406	display and sensor and processor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/13 23:52
-	18	display and (micromechanical with sensor) and processor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/13 23:34
-	332	gaas and (display and sensor and processor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/13 23:35
-	75	pitch and (gaas and (display and sensor and processor))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/13 23:35
-	6374	display same sensor same processor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/13 23:52
-	88	display same sensor same processor same substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/14 00:12
-	0	display same sensor same processor same substrate same intergrated	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/14 00:12
-	8	display with sensor with processor with substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/14 00:29
-	16	"2229822"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/14 00:23
-	2	display with sensor with logic with substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/14 00:29

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-	37	display same sensor same logic same substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/14 00:35
-	8	led same sensor same logic same substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/14 00:37
-	3	light adj emitting same sensor same logic same substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/14 00:38
-	101	pixel and (sensor same logic same substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/14 00:38
-	101	(pixel and (sensor same logic same substrate)) not (display same sensor same processor same substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/14 00:39
-	200	micromechanical adj sensor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/18 14:50
-	9	led and (micromechanical adj sensor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/18 14:50
-	149	digital with pressure with tire	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 14:07
-	31	semiconductor and (digital with pressure with tire)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 14:13
-	1	semiconductor with substrate and (digital with pressure with tire)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 14:16
-	1632	semiconductor with substrate and (mem or mems)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 14:19
-	256	semiconductor with substrate and (mem or mems) and (display or led) and sensor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 14:37
-	60745	((mem or mems) or sensor) and (logic or processor) and (display or led)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 14:43
-	88415	(common or "same") near3 substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 14:41

-	173115	(common or "same") with substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 14:42
-	2307	((mem or mems) or sensor) and (logic or processor) and (display or led) and ((common or "same") with substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 14:42
-	123	((mem or mems) or sensor) and (logic or processor) and (display or led) same (common with substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 14:44
-	66	((mem or mems) or sensor) and (logic or processor) and (display or led) same (common near2 substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 14:50
-	1	((mem or mems) or sensor) same (logic or processor) same (display or led) same (common near2 substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 14:51
-	3106	digital with pressure with sensor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 14:51
-	4684	digital with temperature with sensor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 14:51
-	3	(digital with pressure with sensor) same (semiconductor with substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 15:25
-	3	(mem or mems) same substrate same display same (logic or processor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 15:30
-	23	digital with pressure with sensor with tire	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 15:38
-	4	digital with ((temperature with sensor) or thermometer) with tire	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 15:40
-	6568	digital with ((temperature with sensor) or thermometer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 15:40
-	112	(digital with ((temperature with sensor) or thermometer) ) and (semiconductor with substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 16:56
-	3	(integrating with sensor with display) same substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 16:59

-	806	sensor with display with substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 17:00
-	509	semiconductor and (sensor with display with substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/23 12:48
-	1759	tft and led	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/22 11:38
-	66	gaas and (tft and led)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/22 11:38
-	510	semiconductor and (sensor with display with substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/22 15:13
-	19	gaas and (semiconductor and (sensor with display with substrate))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/22 11:56
-	23	active adj matrix adj display and gaas and led	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/22 12:01
-	0	pixel same gaas same led same tft	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/22 12:02
-	10872	pixel same tft	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/22 12:02
-	18	pixel same gaas same led	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/22 12:02
-	510	semiconductor and (sensor with display with substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/22 15:13
-	45	(gaas or gallium) and (semiconductor and (sensor with display with substrate))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/22 17:36
-	34	(led) and (semiconductor and (sensor with display with substrate))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/22 17:36